

Docket No. 312302US40PCT

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

IN RE APPLICATION OF: Hui ZHONG, et al.

SERIAL NO: 10/049,270

FILED: June 27, 2002

FOR: MULTILAYER PRINTED WIRING BOARD, SOLDER RESIST  
COMPOSITION, METHOD FOR MANUFACTURING MULTILAYER  
PRINTED WIRING BOARD, AND SEMICONDUCTOR DEVICE

**CONFIRMATION OF ATTORNEY AND  
CORRESPONDENCE ADDRESS**

COMMISSIONER FOR PATENTS  
ALEXANDRIA, VIRGINIA 22313

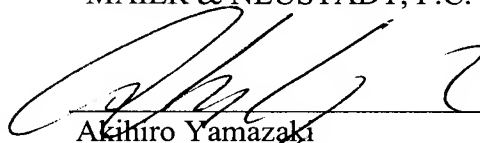
SIR:

The undersigned hereby confirms the attorneys of record for the above-identified application as those appearing in the General Power of Attorney filed herewith, and accordingly requests the appropriate attorneys of record be noted, and the correct correspondence address be entered for this application as the address associated with Customer Number:

**22850**

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND,  
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